### SHARP

		SPEC	No. E RED 62009B
			ISSUE : May 19,2017
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S	PECIF	I C A T I O N	N S
	Product Name	PHOTOCOUPLER	
		·	
	Model No.	PC123	
	Business dealin	g name:PC123X*YUP1B)	l
		pages including the cover and tached sheets shall be both sid	
	irmation of the conter ions with approving s	nts, please be sure to send back ignature on each	ccopy of the
		se contact us before issuing pu	rchasing order.
Accepted by:			
		Sharp Corporation	
By :		ey A	
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Date :		Title : Division Manager	' <b>,</b>
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By : Name :		Semiconductor Bu Electronic Compo	nsiness Unit nents and Devices BU
Title :		Date : May 19, 20	
Date :		V	
		Reviewed by :	Prepared by :
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		Title : Senior Manager	Title : Supervisor
		Date: May. 19, 2017	Date: May 19,2017

- SHARP
- 1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please handle with great cares and do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this Sharp product, please observe the absolute maximum ratings, other conditions and instructions for use described in the specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damages resulting from use of the product which does not comply with absolute maximum ratings, other conditions and instructions for use included in the specification sheets, and the precautions mentioned below.

(Precautions)

- (1) In making catalogue or instruction manual based on the specification sheets, please verify the validity of the catalogue or instruction manuals after assembling Sharp products in customer's products at the responsibility of customer.
- (2) This Sharp product is designed for use in the following application areas;
  - Computers OA equipment Telecommunication equipment (Terminal) Measuring equipment • Tooling machines • Audio visual equipment • Home appliances

If the use of the Sharp product in the above application areas is for equipment listed in paragraphs (3) or (4), please be sure to observe the precautions given in those respective paragraphs.

- (3) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when Sharp product is used for equipment in responsibility of customer which demands high reliability and safety in function and precision, such as ;
  - Transportation control and safety equipment (aircraft, train, automobile etc.)
  - Traffic signals Gas leakage sensor breakers Rescue and security equipment
  - Other safety equipment
- (4)Sharp product is designed for consumer goods and controlled as consumer goods in production and quality. Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;
  - Space equipment Telecommunication equipment (for trunk lines)
  - Nuclear power control equipment Medical equipment
- (5) Please contact and consult with a Sharp sales representative if there are any question regarding interpretation of the above four paragraphs.

#### 3. Disclaimer

The warranty period for Sharp product is one (1) year after shipment.

During the period, if there are any products problem, Sharp will repair (if applicable), replace or refund. Except the above, both parties will discuss to cope with the problems.

The failed Sharp product after the above one (1) year period will be coped with by Sharp, provided that both parties shall discuss and determine on sharing responsibility based on the analysis results thereof subject to the above scope of warranty.

The warranty described herein is only for Sharp product itself which are purchased by or delivered to customer. Damages arising from Sharp product malfunction or failure shall be excepted.

Sharp will not be responsible for the Sharp product due to the malfunction or failures thereof which are caused by:

- (1) storage keep trouble during the inventory in the marketing channel.
- (2) intentional act, negligence or wrong/poor handling.
- (3) equipment which Sharp products are connected to or mounted in.
- (4) disassembling, reforming or changing Sharp products.
- (5) installation problem.
- (6) act of God or other disaster (natural disaster, fire, flood, etc.)
- (7) external factors (abnormal voltage, abnormal electromagnetic wave, fire, etc.)

(8) special environment (factory, coastal areas, hotspring area, etc.)

(9) phenomenon which cannot be foreseen based on the practical technologies at the time of shipment.

(10) the factors not included in the product specification sheet.

4. Please contact and consult with a Sharp sales representative for any questions about Sharp product.

#### 1. Application

This specification applies to the outline and characteristics of photocoupler Model No. PC123 (Lead-Free Type).

2.	Outline	Refer to the attached sheet, page 6.
3.	Ratings and characteristics	Refer to the attached sheet, page 7, 8.
4.	Reliability	Refer to the attached sheet, page 9.

### 5. Outgoing inspection Refer to the attached sheet, page 10.

### 6. Supplement

- 6.1 Isolation voltage shall be measured in the following method.
  - (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
  - (2) The dielectric withstanding tester with zero-cross circuit shall be used.
  - (3) The wave form of applied voltage shall be a sine wave.(It is recommended that the isolation voltage be measured in insulation oil.)
- 6.2 Packing specifications Refer to the attached sheet, page 11, 12.

#### 6.3 Collector current (Ic) Delivery rank table ("O" mark indicates business dealing name of ordered product)

Rank at delivery	* Business dealing name Rank mark		Ic (mA)	Test conditions
	PC123XNYUP1B	with or $\lceil \_ \rfloor$	2.5 to 20.0	I <sub>F</sub> =5mA
	PC123X1YUP1B	L	2.5 to 7.5	V <sub>CE</sub> =5V
	PC123X2YUP1B	М	5.0 to 12.5	Ta=25°C
	PC123X5YUP1B	Ν	10.0 to 20.0	
	PC123X8YUP1B	Е	5.0 to 10.0	

6.4 The relevant models are the models approved by VDE according to DIN EN 60747-5-5. Approved Model No.: PC123

VDE approved No.: 40008087 (According to the specification DIN EN 60747-5-5)

11		0		<b>I</b>
Operating isolation ve	oltage	VIORM	:	1140V (Peak)
<ul> <li>Transient voltage</li> </ul>			:	9000V (Peak)
<ul> <li>Pollution</li> </ul>			:	2
• Clearances distance (	Betwee	n input and output	):	8.0mm (MIN.)
• Creep age distance (H	Between	n input and output)	:	8.0mm (MIN.)
Isolation thickness be	etween i	nput and output	:	0.4mm (MIN.)
<ul> <li>Tracking-proof</li> </ul>			:	CTI 175
<ul> <li>Safety limit values</li> </ul>	Currer	nt (Isi)	:	200mA (Diode side)
	Power	r (Psi)	:	300mW (Phototransistor side)
	Tempe	erature (Tsi)	:	150°C
<b>x</b> 1 1 0				

In order to keep safety electric isolation of photocoupler, please set the protective circuit to keep within safety limit values when the actual application equipment troubled.

• Indication of VDE approval "  $\int_{DE}$  " is printed on minimum unit package.



Isolation specification according to EN 60747-5-5

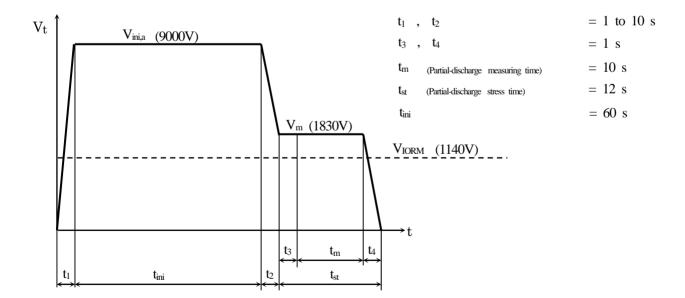
Parameter	Symbol	Condition	Rating	Unit	Remark
Class of environmental test	-	-	55/110/21	-	
Pollution	-	-	2	-	
Maximum operating isolation voltage	VIORM (PEAK)	-	1140	V	Refer to
Partial discharge test voltage (Between input and output)					the Diagram 1
Diagram 1	Vm	tm=10s, qc<5pC	1830	V	(3/12) Refer to
Diagram 2		t <sub>stl</sub> =1s, qc<5pC	2140	V	the Diagram 2
Maximum over-voltage		t <sub>ini</sub> =60s	9000	V	(4/12)
Safety maximum ratings					
1) Case temperature	Tsi	$I_{F}=0, P_{C}=0$	150	°C	Refer to
2) Input current	Isi	Pc=0	200	mA	the Fig. 1, 2 (4/12)
3) Electric power (Output or Total power dissipation	) Psi	-	300	mW	()
Isolation resistance (Test voltage between input and output ; DC500V)		Tamb=Tsi	MIN.109		
		Tamb=100°C	MIN.10 <sup>11</sup>	Ω	
(Test voltage between input and output, DC500V)		Tamb 25°C	MIN.10 <sup>12</sup>		

Precautions in performing isolation test

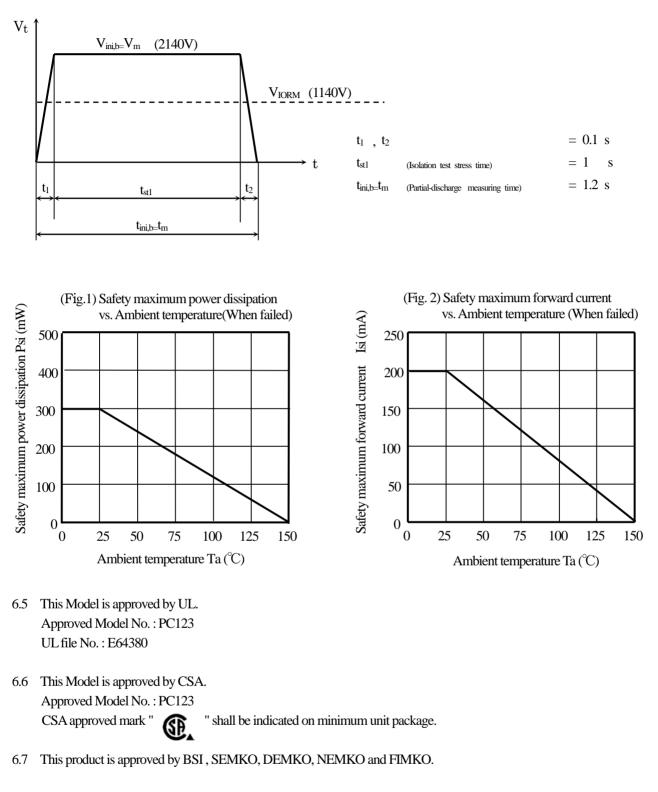
(1) Partial discharge test methods shall be the ones according to the specifications of EN 60747-5-5.

(2) Please don't carry out isolation test (V<sub>iso</sub>) over V<sub>ini,a</sub>.
 This product deteriorates isolation characteristics by partial discharge due to applying high voltage (ex. V<sub>ini,a</sub>).
 And there is possibility that partial discharge occurs in operating isolation voltage. (V<sub>IORM</sub>).

Method of Diagram 1: Breakdown test (Apply to type test and sampling test)



Method of Diagram 2: Non breakdown test (Apply to all device test)



6.8 This product is not designed against irradiation. This product is assembled with electrical input and output. This product incorporates non-coherent light emitting diode.

6.9 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform)

- 6.10 Specified brominated flame retardants Specified brominated flame retardants (PBB and PBDE) are not used in this device at all
- 6.11 Compliance with each regulation
  - The RoHS directive(2011/65/EU) This product complies with the RoHS directive(2011/65/EU).
     Object substances: mercury, lead, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE)
  - (2) Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic Information Products Regulation (Chinese: 电子信息产品污染控制管理力法).

### Marking Styles for the Names and Contents of the Hazardous Substances

		Hazardous Substances								
Category	Lead	Moroury	Cadmium	Hexavalent	Polybrominated	Polybrominated				
Category	(Pb)	Mercury Cadmium (Hg) (Cd)		chromium (Cr <sup>6+</sup> )	biphenyls (PBB)	diphenyl ethers (PBDE)				
Photocoupler	0	0	0	0	0	0				

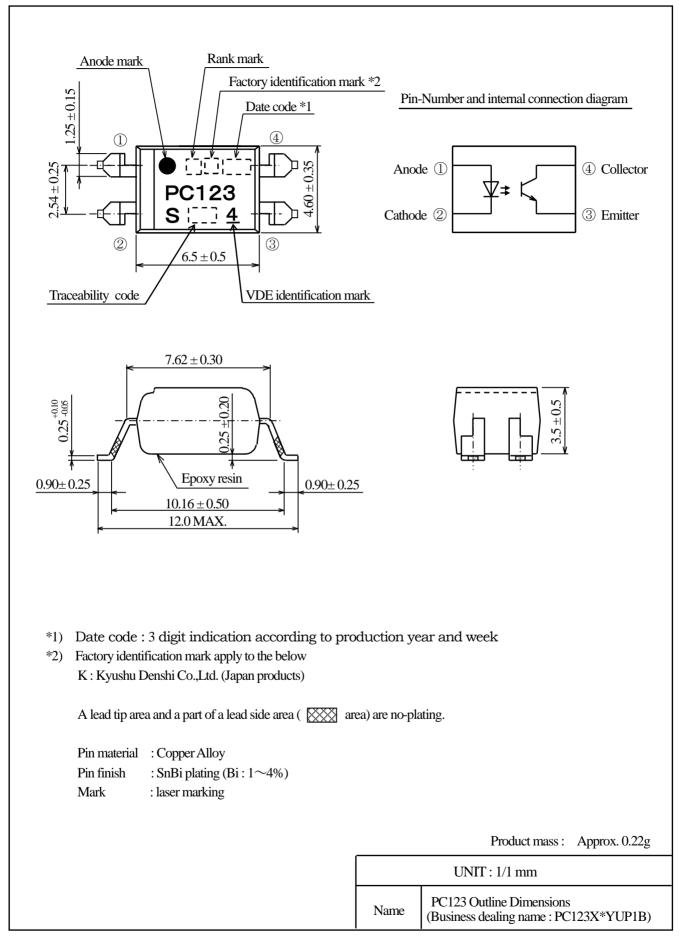
This table is prepared in accordance with the provisions of SJ/T 11364.

 $\bigcirc$ : Indicates that said hazardous substance contained in all of the homogeneous materials for this part is below the limit requirement of GB/T 26572

#### 7. Notes

Precautions for photocouplers : Attachment-1

### 2. Outline



### 3. Ratings and characteristics

3.1 Absolute maximum ratings

Absolute	maximum ratings			Ta=25°C
	Parameter	Symbol	Rating	Unit
	Forward current *1	$I_{\rm F}$	50	mA
Instant	Peak forward current *2	I <sub>FM</sub>	1	А
Input	Reverse voltage	V <sub>R</sub>	6	V
	Power dissipation *1	Р	70	mW
	Collector-emitter voltage	V <sub>CEO</sub>	80	V
Outrout	Emitter-collector voltage	V <sub>ECO</sub>	6	V
Output	Collector current	Ic	50	mA
	Collector power dissipation *1	Pc	150	mW
	Total power dissipation *1	P <sub>tot</sub>	200	mW
	Operating temperature	Topr	-30 to +100	°C
Storage temperature		T <sub>stg</sub>	-55 to +125	°C
	Isolation voltage *3		5	kV
	Soldering temperature *4	T <sub>sol</sub>	270	°C

#### 3.2 Electro-optical characteristics

Ta=25°C

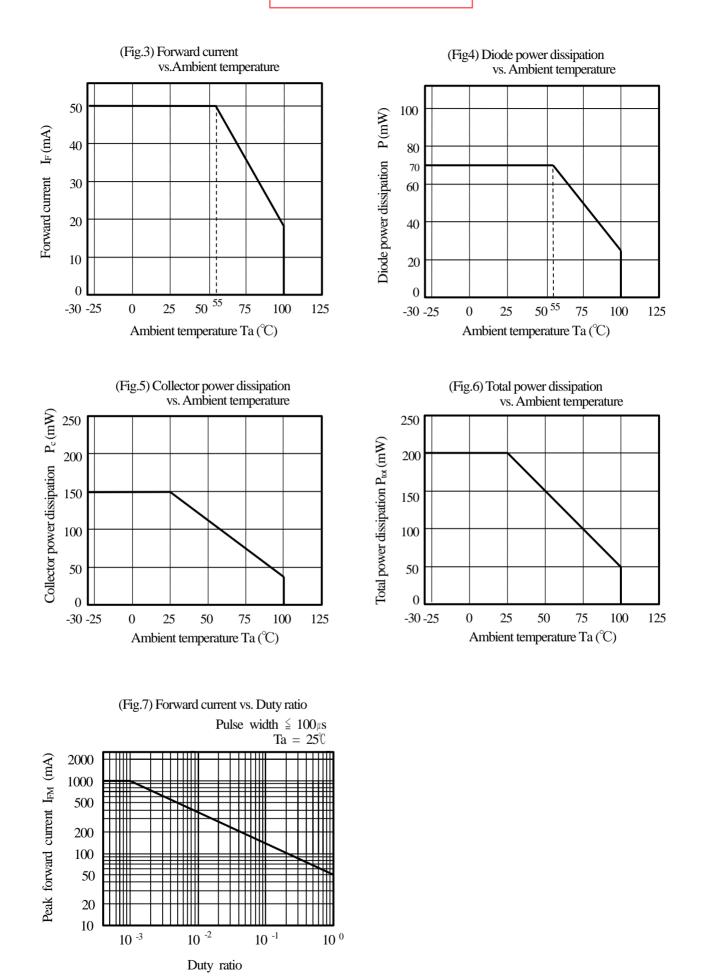
	Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
		Symbol	Condition	IVIIIN.	I I P.	MAA.	Ullit
-	Forward voltage	VF	IF=20mA	-	1.2	1.4	V
Input	Reverse current	I <sub>R</sub>	V <sub>R</sub> =4V	-	-	10	$\mu \mathbf{A}$
	Terminal capacitance	Ct	V=0, f=1kHz	-	30	250	pF
	Dark current	ICEO	V <sub>CE</sub> =50V, I <sub>F</sub> =0	-	-	100	nA
Output	Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>c</sub> =0.1mA, I <sub>F</sub> =0	80	-	-	V
	Emitter-Collector breakdown voltage	BV <sub>ECO</sub>	$I_{E}=10  \mu  A,  I_{F}=0$	6	-	-	V
	Collector current	Ic	IF=5mA, V <sub>CE</sub> =5V	2.5	-	20	mA
	Collector-emitter saturation voltage	$V_{CE(sat)}$	I <sub>F</sub> =20mA, I <sub>c</sub> =1mA	-	0.1	0.2	V
Transfer	Isolation resistance R <sub>ISO</sub>		DC500V 40 to 60% RH	$5 \times 10^{10}$	1011	-	Ω
charac	Floating capacitance	$C_{\mathrm{f}}$	V=0, f=1MHz	-	0.6	1.0	pF
-teristics	Cut-off frequency	fc	$\begin{array}{lll} V_{CE}\!\!=\!\!5V\!, & I_{c}\!\!=\!\!2mA \\ R_{L}\!\!=\!\!100\Omega, & \!\!-\!3dB \end{array}$	-	80	-	kHz
	Response time (Rise)	t <sub>r</sub>	V <sub>CE</sub> =2V, I <sub>c</sub> =2mA	-	4	18	$\mu  \mathbf{s}$
	Response time (Fall) t <sub>f</sub>		$R_L=100\Omega$	-	3	18	$\mu  \mathbf{s}$

\*1 The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 3 to 6.

\*2 Pulse width  $\leq 100 \,\mu$  s, Duty ratio : 0.001 (Refer to Fig. 7)

\*3 AC for 1 min, 40 to 60%RH

\*4 For 10s





### 4. Reliability

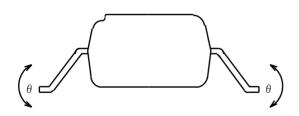
The reliability of products shall satisfy items listed below.

```
Confidence level : 90%
```

		LTPD	: 10 or 20
Test Items	Condition *1	Failure Judgment Criteria	Samples (n) Defective (C)
Solderability	245±3°C, 5s	*2	n=11, C=0
Coldering heat	(Flow soldering) 270°C, 10 s		n=11, C=0
Soldering heat	(Soldering by hand) 400°C, 3 s		n=11, C=0
Terminal strength (Tension)	Weight: 5N 5 s/each terminal	$V_{F} > U \times 1.2$ $I_{R} > U \times 2$	n=11, C=0
Terminal strength (Bending) *3	Weight: 2.5N 2 times/each terminal	$I_{CEO} > U \times 2$ $I_C < L \times 0.7$	n=11, C=0
Mechanical shock	$\frac{15 \text{km/s}^2, 0.5 \text{ms}}{3 \text{ times/}\pm X, \pm Y, \pm Z \text{ direction}}$	$V_{CE(sat)} > U \times 1.2$	n=11, C=0
Variable frequency vibration	100 to 2000 to 100Hz/4 min 200m/s <sup>2</sup> 4 times/X, Y, Z direction	U: Upper specification limit L: Lower specification limit	n=11, C=0
Temperature cycling	1 cycle -55°C to +125 °C (30 min) (30 min) 20 cycles test		n=22, C=0
High temp. and high Humidity storage	+85°C, 85%RH, 1000h		n=22, C=0
High temp. storage	+125°C, 1000h	]	n=22, C=0
Low temp. storage	-55°C, 1000h	]	n=22, C=0
Operation life	I <sub>F</sub> =50mA, P <sub>tot</sub> =200mW Ta=25°C, 1000h		n=22, C=0

<sup>\*1</sup> Test method, conforms to EIAJ ED 4701.

\*3 Terminal bending direction is shown below.



\* These test results are sampling examples from a specific lot for reference purpose only, and do not constitute any warranty or assurance in connection with the products.

<sup>\*2</sup> The product whose not-soldered area is more than 5% for all of the dipped area and/or whose pinholes or voids are concentrated on one place shall be judged defect.



### 5. Outgoing inspection

- 5.1 Inspection items
  - (1) Electrical characteristics
    - $V_{F}\!, I_{R}\!, I_{C\!E\!O}\!, V_{C\!E\,(\text{sat})}\!, I_{c}\!, R_{I\!S\!O}\!, V_{i\!s\!o}$
  - (2) Appearance
- 5.2 Sampling method and Inspection level

LTPD sampling inspec	Confidence level: 90%	
Defect	Inspection item	LTPD (%)
Major defect	Electrical characteristics(faiure) Marking (Unreadable) Lead form (Deformation)	3
Minor defect	Appearance defect except the above mentioned.	50

#### 6.2 Package specifications

6.2.1 Taping conditions

- Tape structure and Dimensions (Refer to below in this page.)
   The carrier tape has the heat pressed structure of PS material carries tape and PET material cover tape.
- (2) Reel structure and Dimensions (Refer to the attached sheet, Page 12) The taping reel shall be of plastic (PS material)
- (3) Direction of product insertion (Refer to the attached sheet, Page 12)
- (4) The cover tape and carrier tape in one weel shall be joint less.
- (5) To repair failure-taped devices, cutting a bottom of carrier tape or a cover tape with a cutter. After replacing the cut portion shall be sealed with adhesive tape.
- 6.2.2 Adhesiveness of cover tape The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N
- 6.2.3 Rolling method and quantity

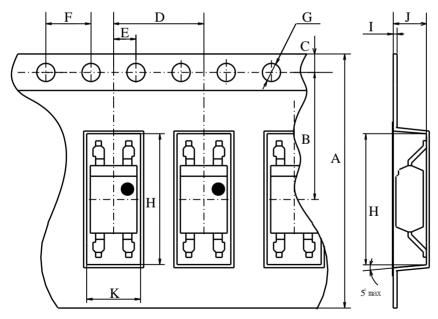
Wind the tape back on the reel so that the cover tape will be outside the tape. Attach more than 18cm of blank tape to the trailer and the leader of the tape And fix the leader with adhesive tape. One reel basically contain 2000pcs

- 6.2.4 Outer packing appearance (Refer to the attached sheet, Page 12)
- 6.2.5 The label with following information shall be pasted at appointed place of the outer packing case.
  \*Model No. \*(Business dealing name) \*Lot No. \*Quantity
  \*Country of origin \*Company name \*Inspection date specified
- 6.2.6 Storage condition

Taped products shall be stored at the temperature 5 to  $30^\circ$ C and the humidity 70%RH or less away from direct sunlight.

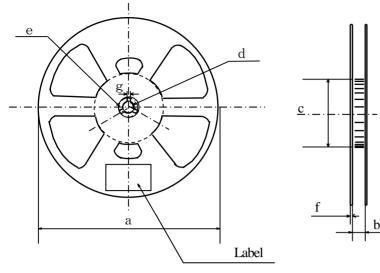
6.2.7 Safety protection during shipping There shall be no deformation of component or degradation of electrical characteristics due to shipping.

Carrier tape structure and Dimensions



Dimensio	ons list	(Unit:mm)								
А	В	С	D	Е	F	G	Н	Ι	J	K
24.0±0.3	11.5±0.1	1.75±0.1	8.0±0.1	2.0±0.1	4.0±0.1	φ 1.5 <sup>+0.1</sup> <sub>-0</sub>	12.5±0.1	0.40±0.05	4.05±0.1	5.3±0.1

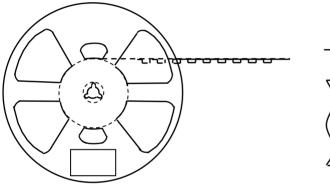
Reel structure and Dimensions



Dimensions list (Unit : mm)

а	b	с	d
(330)	25.5±1.5	$\phi$ 100.0±1.0	$\phi$ 13.0 $\pm$ 0.5
e	f	g	
$\phi 21.0 \pm 1.0$	2.0±0.5	2.0±0.5	

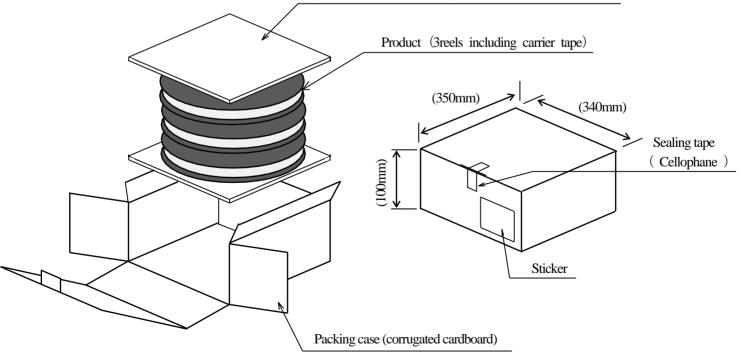
Direction of product insertion



Pull-out direction						
$\sum$	0	0	0	0	0	$\sum$
/	Æ	ł	Æ	ł	Æ	Ţ
		•		•		٦
)	Ŀ	Ŧ	Ŀ	Ŧ	Ŀ	7

Outer packing appearance

Cushioning Pad(Each one sheet in top side and bottom side) (PE with antistatic treatment)



Regular packing mass : Approx. 2.9kg ( ): Reference dimensions



#### Precautions for Photocouplers

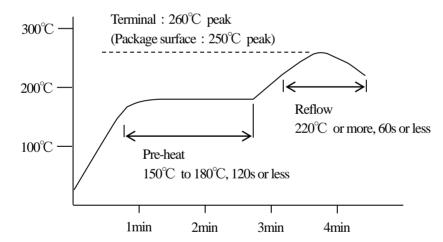
#### 1 Cleaning

(1)	Solvent cleaning : S	Solvent temperature $45^{\circ}$ C or less			
	Immersion for 3 min or less				
(2)	Ultrasonic cleaning :	The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output,			
		cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition			
		and confirm that any defect doesn't occur before starting the ultrasonic cleaning.			
(3)	Applicable solvent :	Ethyl alcohol, Methyl alcohol, Isopropyl alcohol			
		When the other solvent is used, there are cases that the packaging resin is eroded.			
		Please use the other solvent after thorough confirmation is performed in actual using condition.			
Circuit design					

#### ( 2.

- (1) The LED used in the Photocoupler generally decreases the light emission power by operation. In case of long operation time, please design the circuit in consideration of the degradation of the light emission power of the LED. (50%/5years)
- (2) There are cases that the deviation of the IC and the degradation of the relative light emission power of the LED increase when the setting value of I<sub>F</sub> is less than 1.0mA. Please design the circuit in consideration of this point.
- Precautions for Soldering 3.
  - (1) In the case of flow soldering (Whole device dipping.) It is recommended that flow soldering should be at  $270^{\circ}$ C or less for 10 s or less (Pre-heating : 100 to 150°C, 30 to 80s). (2 times or less)
  - (2) If solder reflow :

It is recommended to be done at the temperature and the time within the temperature profile as shown in the figure below. (2 times or less)



(3) In the case of hand soldering

What is done on the following condition is recommended.(2 times or less) Soldering iron temperature : 400°C or less Time: 3s or less

(4) The form of a lead tip part

There is production tolerance as shown in the following figure



(5) Other precautions

Depending on equipment and soldering conditions (temperature, Using solder etc.), the effect to the device and the PCB is different.

Please confirm that there is no problem on the actual use conditions in advance.

#### Attachment-1

### **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Transistor Output Optocouplers category:

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Other Similar products are found below :

LTV-814S-TA LTV-824HS 66095-001 6N136-X017T MCT6-X007 MOC8101-X017T PS2561A-1-W-A PS2561B-1-L-A PS2561L-1-V-A MRF658 IL755-1X007 ILD2-X006 ILD74-X001 ILQ615-2X017 ILQ615-3X016 LDA102S LDA110S PS2561-1-V-W-A PS2561AL-1-V-A PS2561L1-1-L-A PS2701A-1-F3-P-A PS2801-1-F3-P-A PS2911-1-L-AX CNY17-2X017 CNY17-4X001 CNY17-4X017 CNY17F-1X007 CNY17F-2X017 CNY17F-4X001 CNY17G-1 LTV-214 LTV-702VB LTV-733S LTV-816S-TA LTV-825S TCET1113 TCET2100 4N25-X007T IL215AT ILD615-1X007 ILQ2-X007 VOS615A-2T WPPC-A11066AA WPPC-A11066AD WPPC-A11084ASS WPPC-A21068AA WPPC-D11066AA WPPC-D21068ED WPPC-D410616EA WPPC-D410616ED